	۵	μ	Document ID	Issue Date	Pages	Title	Current OR
Н	⊠		US 6278264 B1	20010821	18	Flip-chip switching regulator 323/282	323/282
2	☒		US 6206705 B1	20010327	ω	Three-dimensional modular electronic interconnection system	439/69
ω	⊠		US 5787174 A	19980728	10	Remote identification of integrated circuit	713/189
4	☒		US 5779839 A	19980714	23	Method of manufacturing an enclosed transceiver	156/213
U	×		US 5724728 A	19980310	7	Method of mounting an integrated circuit to a mounting surface	29/840
0	×		□ US 5451715 A	19950919	æ	Molded package integrated circuit with electrochemical cell	174/52.4

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	Current XRef	257/700	257/704;	361/726;	439/66;	439/74	324/764;	342/44;	380/270;	438/19;	713/168 •	156/308.4; 29/855		439/73	257/678
7) 1	Retrieval Classif														
	Inventor	Burstein, Andrew J. et al.		Bolotin Gary S et al	Oat y 0. Cc				Tuttle, John R.			Tuttle, Mark E. et al.		Bond, Robert H. et al.	Hundt, Michael J. et al.
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